UNIKC Semiconductor

RoHS Compliant

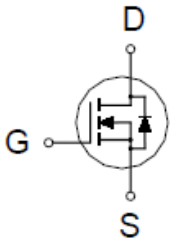
P1203BEA

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30V	12mΩ @V_{GS} = 10V	35A

PDFN 3x3P



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current	T_C = 25 °C	I_D	35	A
	T_C = 100 °C		22	
	T_A = 25 °C		12	
	T_A = 70 °C		10	
Pulsed Drain Current[1]		I_{DM}	95	
Avalanche Current		I_{AS}	28	
Avalanche Energy	L = 0.1mH	E_{AS}	39	mJ
Power Dissipation	T_C = 25 °C	P_D	25	W
	T_C = 100 °C		10	
	T_A = 25 °C		3	
	T_A = 70 °C		2	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

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THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	t ≦10s	$R_{\theta JA}$		40	°C / W
Junction-to-Ambient	Steady-State	$R_{\theta JA}$		75	
Junction-to-Case	Steady-State	$R_{\theta JC}$		5	

[1]Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.3	1.8	2.5	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V			0.1	μA
		V_{DS} = 20V, V_{GS} = 0V , T_J = 125 °C			1	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 5V, V_{GS} = 10V	95			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 11A		13	17.5	mΩ
		V_{GS} = 10V, I_D = 11A		8	12	
Forward Transconductance[1]	g_{fs}	V_{DS} = 10V, I_D = 11A		22		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz		911		pF
Output Capacitance	C_{oss}			225		
Reverse Transfer Capacitance	C_{rss}			124		
Total Gate Charge[2]	$Q_{g(VGS=10V)}$	V_{DS} = 0.5$V_{(BR)DSS}$, I_D = 11A		15.7		nC
	$Q_{g(VGS=4.5V}$			6.8		
Gate-Source Charge[2]	Q_{gs}			2.6		
Gate-Drain Charge[2]	Q_{gd}			4		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		1.7		Ω
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DD} = 15V, I_D ≅ 11A, V_{GEN} = 10V, R_G = 6Ω		9.8		nS
Rise Time[2]	t_r			12.2		
Turn-Off Delay Time[2]	$t_{d(off)}$			9.7		
Fall Time[2]	t_f			11.7		

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SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I_S				35	A
Forward Voltage[1]	V_{SD}	I_F = 11A, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	I_F = 11A, dI_F/dt = 100A / μS		30		nS
Reverse Recovery Charge	Q_{rr}			41		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

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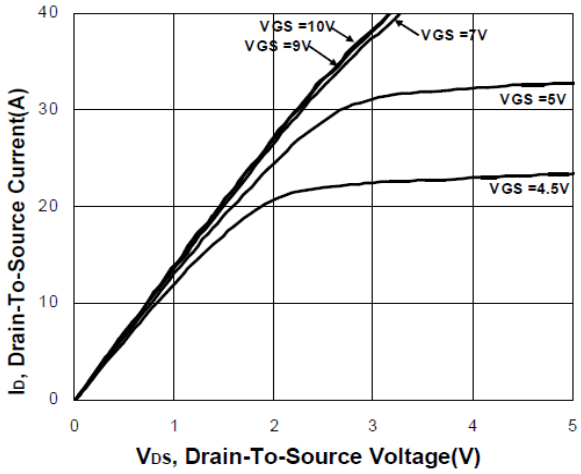
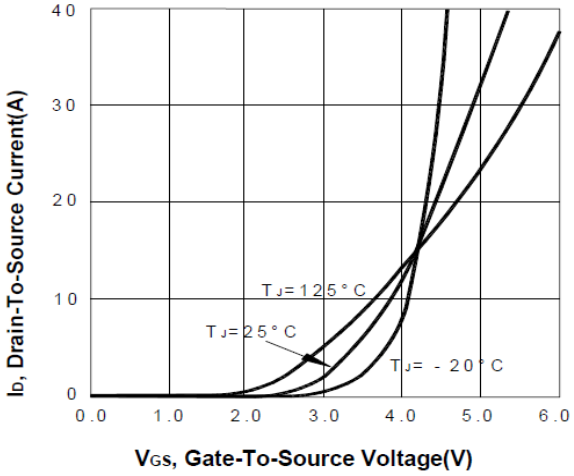
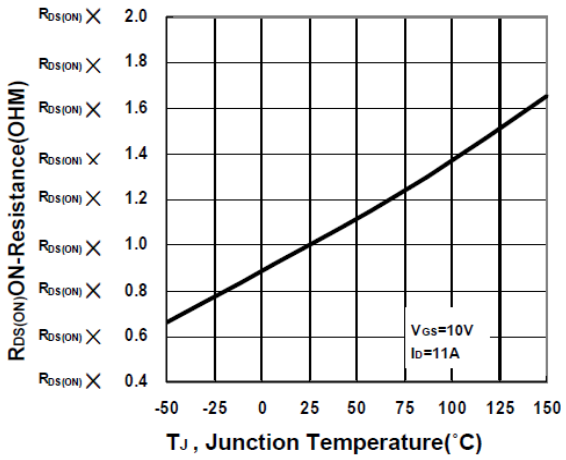
Output Characteristics



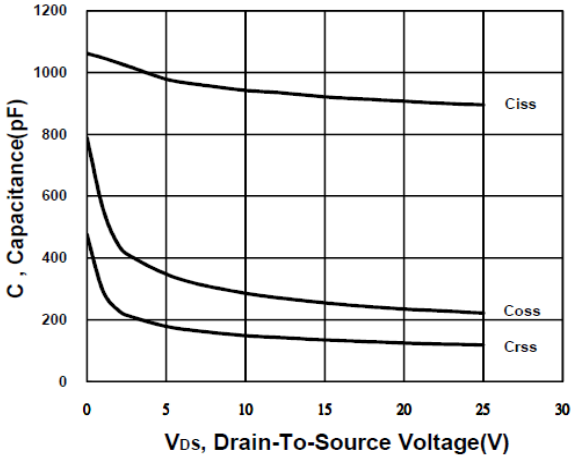
Transfer Characteristics



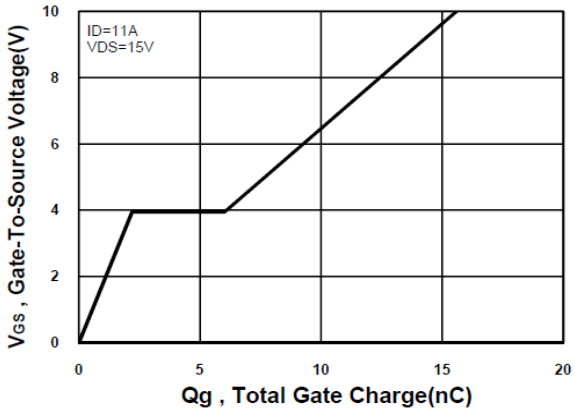
On-Resistance VS Temperature



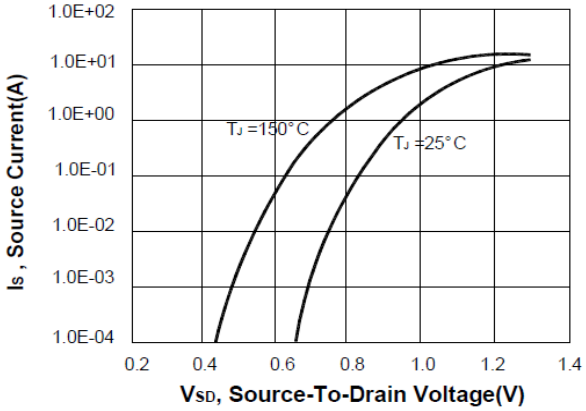
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



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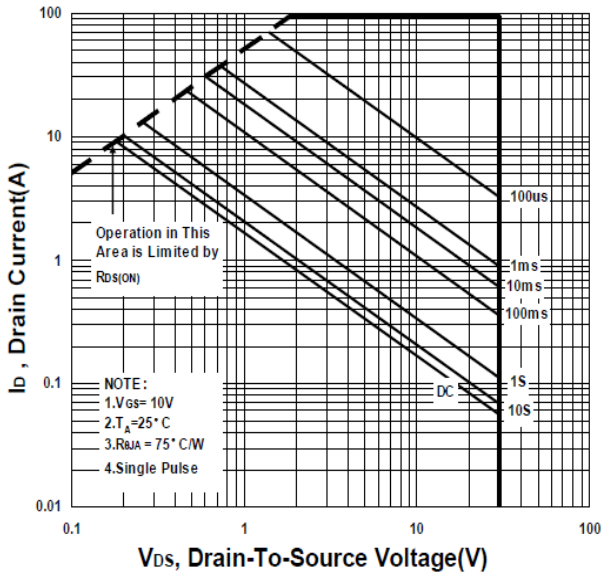
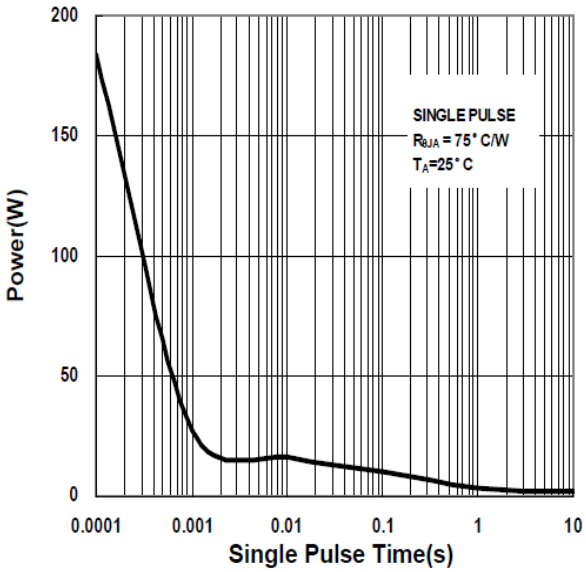
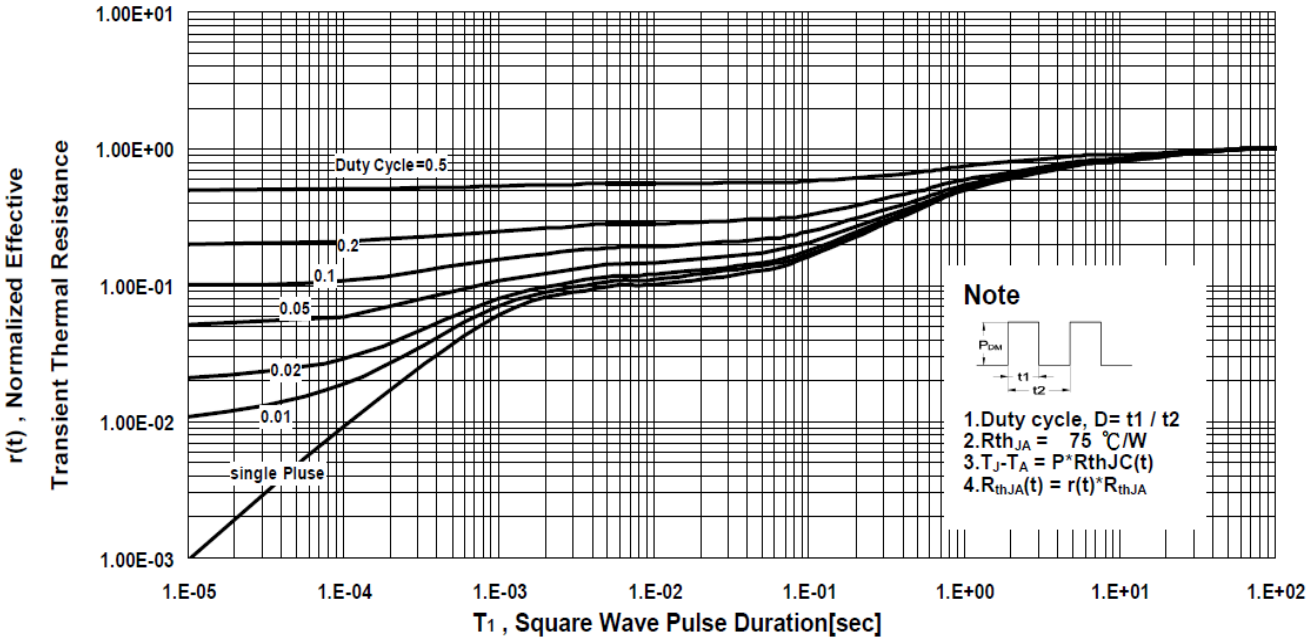
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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Package Dimension

PDFN 3x3P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3		3.6	I	0.7		1.12
B	2.88		3.2	J	0.1		0.33
C	2.9		3.2	K	0.6		
D	1.98		2.69	L	0°	10°	12°
E	3		3.6	M	0.14		0.41
F	0		0.455	N	0.6		0.7
G	1.47		2.2	O	0.12		0.36
H	0.15		0.56	P	0		0.2